

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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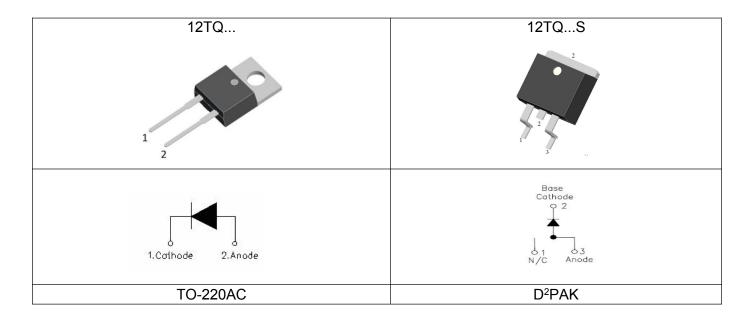
12TQ035/S 12TQ040/S 12TQ045/S SCHOTTKY RECTIFIER

Features

- 150[°]C T_J operation
- High purity, high temperature epoxy encapsulation for enhanced mechanical strength and moisture resistance
- Low forward voltage drop
- High frequency operation
- Guard ring for enhanced ruggedness and long term reliability
- This is a Pb Free Device
- All SMC parts are traceable to the wafer lot
- Additional testing can be offered upon request

Applications

- Switching power supply
- · Redundant power subsystems
- Converters
- Free-Wheeling diodes
- Reverse battery protection



Maximum Ratings:

Characteristics	Symbol	Condition		Max.	Units
Peak Repetitive Reverse Voltage	V_{RRM}	-	35	12TQ035	
Working Peak Reverse Voltage	V _{RWM}		40	12TQ040	V
DC Blocking Voltage	V _R		45	12TQ045	1
Average Rectified Forward Current	I _{F (AV)}	50% duty cycle @Tc=120°C, rectangular wave form	15		Α
Peak One Cycle Non-Repetitive Surge Current	I _{FSM}	8.3ms, Half Sine pulse	300		Α
Non-Repetitive Avalanche Energy	E _{AS}	T _J =25℃,I _{AS} =0.5A,L=60mH		16	mJ
Repetitive Avalanche Current	lar	Current decaying linearly to zero in 1 µsec Frequency limited by T _J max.V _A =1.5×V _R typical	2.4		А

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Electrical Characteristics:

Characteristics	Symbol	Condition	Тур.	Max.	Units
Forward Voltage Drop*	V _{F1}	@ 15A, Pulse, T _J = 25 °C @ 30A, Pulse, T _J = 25 °C	0.55 0.61	0.56 0.71	٧
	V _{F2}	@ 15A, Pulse, T _J = 125 °C @ 30A, Pulse, T _J = 125 °C	0.45 0.54	0.50 0.64	٧
Reverse Current *	I _{R1}	$@V_R = \text{rated } V_R$ $T_J = 25 ^{\circ}\mathbb{C}$	0.06	1.0	mA
	I _{R2}	$@V_R = \text{rated } V_R$ $T_J = 125 \degree C$	4	70	mA
Junction Capacitance	Ст	@ V_R = 5V, T_C = 25 °C f_{SIG} = 1MHz	700	900	pF
Series Inductance	Ls	Measured lead to lead 5 mm from package body	8.0	-	nH
Voltage Rate of Change	dv/dt	-	-	10,000	V/µs

 $^{^{\}star}\,$ Pulse width < 300 $\mu s,\,$ duty cycle < 2%

Thermal-Mechanical Specifications:

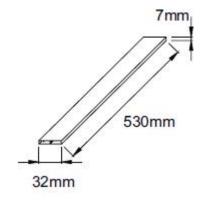
Characteristics	Symbol	Condition	Specification	Units
Junction Temperature	TJ	-	-55 to +150	°C
Storage Temperature	T _{stg}	-	-55 to +150	°C
Typical Thermal Resistance Junction to Case	$R_{ heta JC}$	DC operation	2.0	°C/W
Typical Thermal Resistance Case to Heat Sink	R _{0CS}	Mounting surface, smooth and greased(only for TO-220)	0.50	°C/W
Case Style	TO-220AC D ² PAK			

Tube Specification

Device	Package	Weight	Shipping
12TQ	TO-220AC	1.8g	50pcs / tube
12TQS	D² PAK	1.85g	800pcs / reel

For information on tape and reel specifications, including part orientation and tape sizes, please refer to our tape and reel packaging specification.

Tube Specification(TO-220AC)



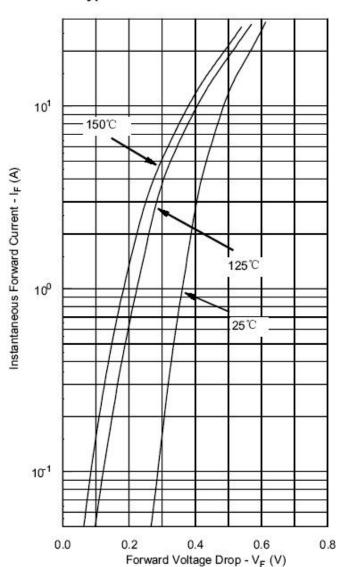




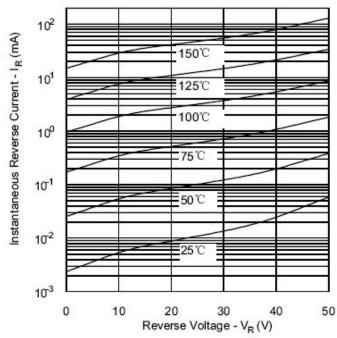


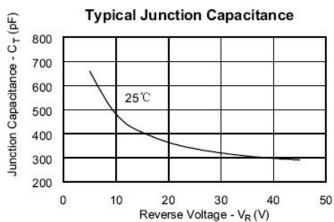
Ratings and Characteristics Curves

Typical Forward Characteristics



Typical Reverse Characteristics





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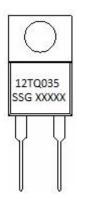
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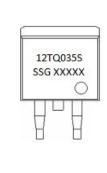






Marking Diagram





Where XXXXX is YYWWL

12 = Forward Current (12A)

TQ = Device Type 35/40/45 = Reverse Voltage (35/40/45V)

S = Package type

 SSG
 = SSG

 YY
 = Year

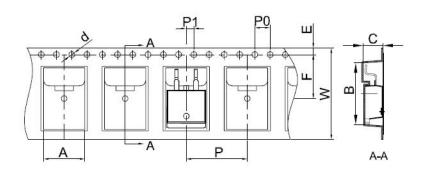
 WW
 = Week

 L
 = Lot Number

Cautions: Molding resin

Epoxy resin UL:94V-0

Carrier Tape Specification D²PAK



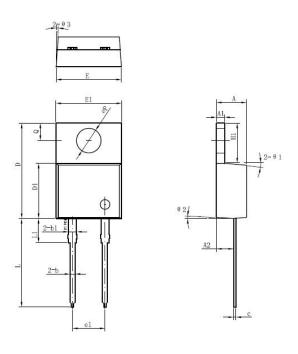
Symbol	Millimeters			
Symbol	Min.	Max.		
А	10.70	10.90		
В	16.03	16.23		
С	5.11	5.31		
d	1.45	1.65		
E	1.65	1.85		
F	11.40	11.60		
P0	3.90	4.10		
Р	15.90	16.10		
P1	1.90	2.10		
W	23.90	24.30		





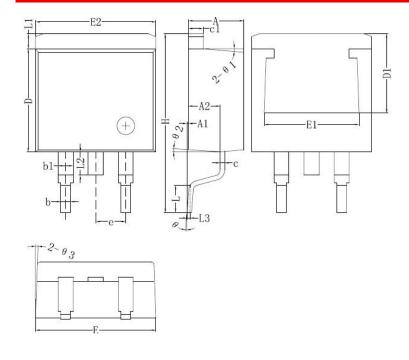


Mechanical Dimensions TO-220AC



Symbol	Dimensions in millimeters			
	Min.	Typical	Max.	
Α	4.47	4.70	4.85	
A1	1.17	1.27	1.37	
A2	2.52	2.69	2.89	
b	0.71	0.81	0.96	
b1	1.17	1.27	1.37	
С	0.31	0.38	0.61	
D	14.64	14.94	15.24	
D1	8.50	8.07	8.90	
E	10.01	10.16	10.31	
E1	9.98	10.18	10.38	
e1	4.98	5.08	5.18	
H1	6.04	6.24	6.44	
L	13.00	13.86	14.08	
L1	3.56	3.80	3.96	
ФР	3.74	3.84	4.04	
Q	2.54	2.74	2.94	
Θ1		5°		
Θ2		4°		
Θ3		4°		

Mechanical Dimensions D²PAK



Symbol	Millimeters				
	Min.	Typical	Max.		
Α	4.47	4.70	4.85		
A1	0	0.10	0.25		
A2	2.59	2.69	2.89		
b	0.71	0.81	0.96		
b1	1.17	1.27	1.37		
С	0.31	0.38	0.61		
c1	1.17	1.27	1.37		
D	8.50	8.70	8.90		
D1	6.40				
E	10.01	10.16	10.31		
E1	7.6				
E2	9.98	10.08	10.31		
е		2.54			
Н	14.6	15.1	15.6		
L	2.00	2.30	2.74		
L1	1.12	1.27	1.42		
L2	1.30		2.20		
L3		0.25BSC			
е	0	-	8°		
e1		5°			
e2		4°			
e3		4°			

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